

ESD/ESL SERIES END-STACKABLE SMT TYPE



FEATURES

- End stackable for standard 0.1" integrated circuit pitch.
- Molded 0.3" integrated circuit packing outline allowing automatic insertion.
- Smaller size makes better heat convection during PC board reflow wave soldering.
- Top tape sealed to withstand wave soldering, board washing.
- All plastics are UL 94V-0 grade fire retardant.
- Twin contacts designed to ensure stable contact.
- Gold plated contact to ensure low contact resistance and Tin plated terminals to prevent contamination during soldering.

SPECIFICATIONS

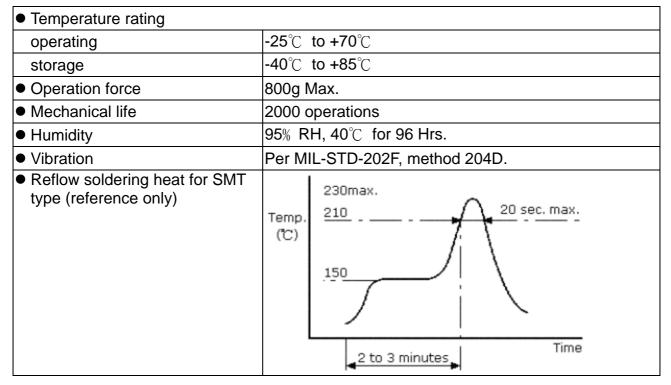
1.ELECTRICAL

Contact rating	
switching	25mA, 24VDC
non-switching	100mA
Contact resistance	
initial	50m Ω Max.
after life test	100m Ω Max.
Insulation resistance	1000MΩ Min. at 100VDC
 Dielectric strength 	500VDC Min. for 60 seconds
 Capacitance between adjacent switches 5pF Max. 	

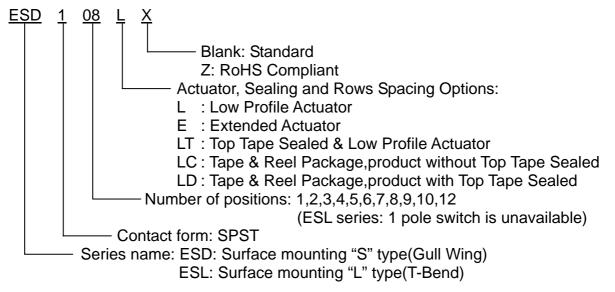
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2.MECHANICAL and ENVIRONMENTAL



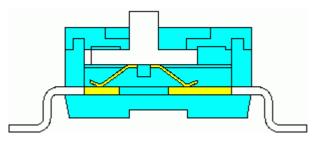
PART NUMBERING SYSTEM





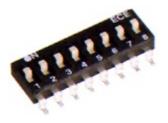
DIP Switch

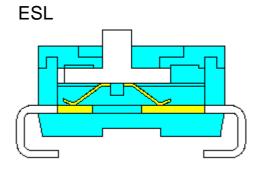
ESD



OPTIONS

1.Special marking and case color available 2.Extended Actuator

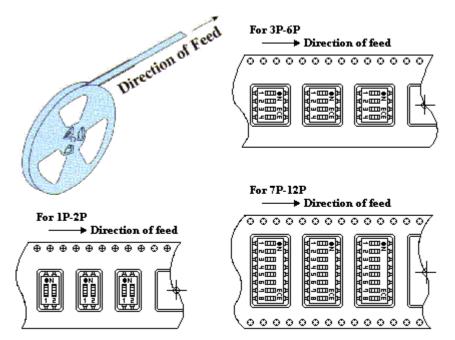




3.Top Tape Sealed



4. Tape & Reel Packaging (per EIA STANDARD)

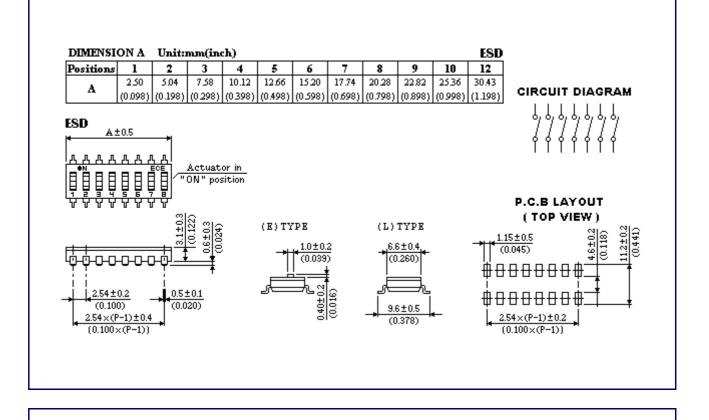


Pole	No. of pcs per reel
1 P	2000
2P	1300
3 P	1000
4 P	1000
5P	1000
6P	1000
7 P	1000
8P	1000
10P	1000
12P	1000

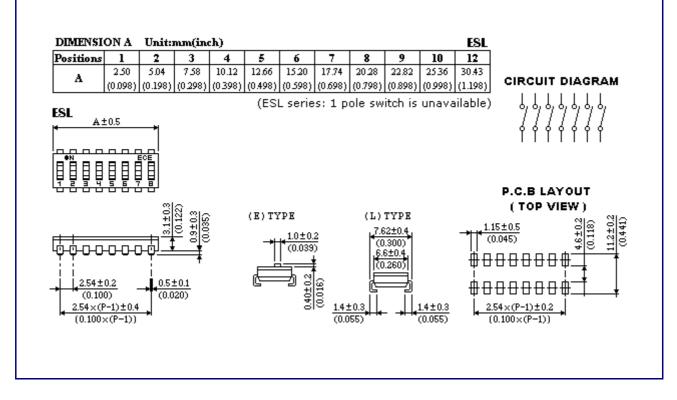
(ESL series: 1 pole switch is unavailable)



DIMENSIONS AND CIRCUITRY



DIP Switch



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